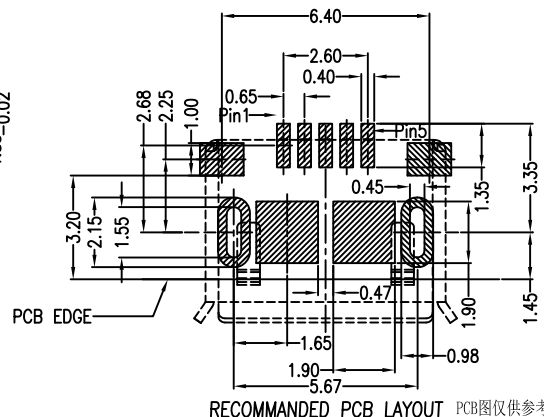
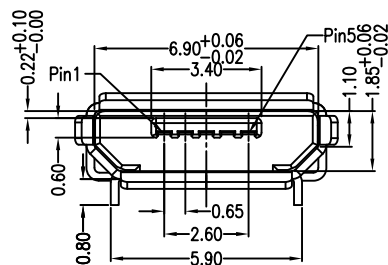
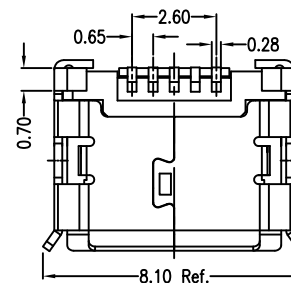
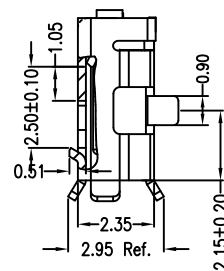
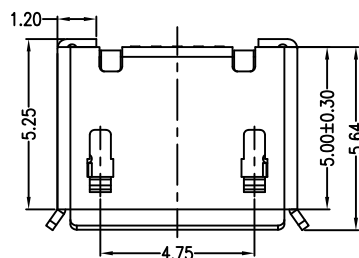
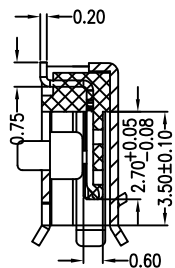
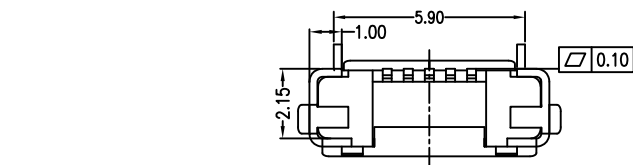


RoHS

MAPX

MODIFICATION

DATE



Note:

1.Material:

- 1.1 Housing: High temperature thermoplastic with g.f,UL94v-0
- 1.2 Contact: copper alloy,t=0.20mm contact area Au flash plating;
- 1.3 Shell:copper or SUS304,t=0.25mm Sn planting 60U" min.

2.Specification:

- 2.1 Current rating:1,5PIN 1.8A Max/2,3,4PIN 1A Max.
- 2.2 Dielectric withstanding voltage: 100 V(ac) for 1 min.
- 2.3 Contact resistance: 30 mΩ Max.
- 2.4 Insulation resistance: 100 MΩ Min.
- 2.5 Total mating force: 3.57 Kgf Max.
- 2.6 Total unmating force: 1.0 Kgf Min.
- 2.7 Temperature range: -30°C~80°C
- 2.8 Solderability: 90% area min;

产品图

PRODUCT CHART DWG

公差一览表

TOLERANCE UNLESS OTHERWISE

X.	±0.35	X.	±5.°
.X	±0.20	.X	±2.°
.XX	±0.10	.XX	±1.°
.XXX	±0.05	.XXX	±0.5°

深圳市精拓金电子有限公司

单位
UNITS

MM

制图
DRAWING

许榕强

制图料号
PRODUCT PART NO.

920-C52A2021S10114

比例
SCALE

1:1

审核
CHKD

郭治富

产品名称
PRODUCT NO.

MICRO-SS-F B型两脚插板有边5.9无柱加焊脚

日期
DATE

2016-09-09

核准
APPD

黄国荣

角法
VIEW版本
VER

A0